## MAX5974A/MAX5974B/

MAX5974C/MAX5974D

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## General Description

The MAX5974_ provide control for wide-input-voltage, active-clamped, current-mode PWM, forward converters in Power-over-Ethernet (PoE) powered device (PD) applications. The MAX5974A/MAX5974C are well-suited for universal or telecom input range, while the MAX5974B/ MAX5974D also accommodate low input voltage down to 10.5 V .
The devices include several features to enhance supply efficiency. The AUX driver recycles magnetizing current instead of wasting it in a dissipative clamp circuit. Programmable dead time between the AUX and main driver allows for zero-voltage switching (ZVS). Under light-load conditions, the devices reduce the switching frequency (frequency foldback) to reduce switching losses.
The MAX5974A/MAX5974B feature unique circuitry to achieve output regulation without using an optocoupler, while the MAX5974C/MAX5974D utilize the traditional optocoupler feedback method. An internal error amplifier with a $1 \%$ reference is very useful in nonisolated design, eliminating the need for an external shunt regulator.
The devices feature a unique feed-forward maximum duty-cycle clamp that makes the maximum clamp voltage during transient conditions independent of the line voltage, allowing the use of a power MOSFET with lower breakdown voltage. The programmable frequency dithering feature provides low-EMI, spread-spectrum operation.
The MAX5974_ are available in 16-pin TQFN-EP packages and are rated for operation over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ temperature ranges.

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## Features

- Peak Current-Mode Control, Active-Clamped Forward PWM Controller
- Regulation Without Optocoupler (MAX5974A/ MAX5974B)
- Internal 1\% Error Amplifier
- 100 kHz to 600 kHz Programmable $\pm 8 \%$ Switching Frequency, Synchronization Up to 1.2 MHz
- Programmable Frequency Dithering for Low-EMI, Spread-Spectrum Operation
- Programmable Dead Time, PWM Soft-Start, Current Slope Compensation
- Programmable Feed-Forward Maximum Duty-Cycle Clamp, 80\% Maximum Limit
- Frequency Foldback for High-Efficiency Light-Load Operation
- Internal Bootstrap UVLO with Large Hysteresis
- $100 \mu \mathrm{~A}$ (typ) Startup Supply Current
- Fast Cycle-by-Cycle Peak Current-Limit, 35ns Typical Propagation Delay
- 115ns Current-Sense Internal Leading-Edge Blanking
- Output Short-Circuit Protection with Hiccup Mode
- Reverse Current Limit to Prevent Transformer Saturation Due to Reverse Current
- Internal 18V Zener Clamp on Supply Input
- $3 \mathrm{~mm} \times 3 \mathrm{~mm}$, Lead-Free, 16-Pin TQFN-EP


## Applications

- PoE IEEE ${ }^{\circledR}$ 802.3af/at Powered Devices
- High-Power PD (Beyond the 802.3af/at Standard)
- Active-Clamped Forward DC-DC Converters
- IP Phones
- Wireless Access Nodes
- Security Cameras

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## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## Absolute Maximum Ratings

| IN to GND ( $\mathrm{V}_{\mathrm{EN}}=0 \mathrm{~V}$ ).....................................-0.3V to +26 V | Maximum Input/Output Current (continuous) |
| :---: | :---: |
| NDRV, AUXDRV to GND.........................-0.3V to ( $\mathrm{V}_{\text {IN }}+0.3 \mathrm{~V}$ ) | EN.......................................................................... 1 mA |
| RT, DT, FFB, COMP, SS, DCLMP, DITHER/SYNC to GND................................................................-0.3V to +6 V | NDRV, AUXDRV (pulsed for less than 100ns) .................. $\pm 1 \mathrm{~A}$ Continuous Power Dissipation ( $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ ) |
| FB to GND (MAX5974A/MAX5974B only) ...............-6V to +6V | 16-Pin TQFN (derate $20.8 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) $\ldots . . .1666 \mathrm{~mW}$ |
| FB to GND (MAX5974C/MAX5974D only).............-0.3V to +6V | Operating Temperature Range...................... $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| CS, CSSC to GND ............................................-0.8V to +6V | Maximum Junction Temperature ................................. $+150^{\circ} \mathrm{C}$ |
| PGND to GND ...............................................-0.3V to +0.3V | Storage Temperature Range ......................... $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
|  | Lead Temperature (soldering, 10s) .............................. $+300^{\circ} \mathrm{C}$ |
|  | Soldering Temperature (reflow).................................. $+260^{\circ} \mathrm{C}$ |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Package Information

| PACKAGE TYPE: 16 TQFN | $\mathrm{T} 1633+4$ |
| :--- | :--- |
| Package Code | $\underline{21-0136}$ |
| Outline Number | $\underline{90-0031}$ |
| Land Pattern Number | $48^{\circ} \mathrm{C} / \mathrm{W}$ |
| THERMAL RESISTANCE, FOUR-LAYER BOARD |  |
| Junction to Ambient $\left(\theta_{\mathrm{JA}}\right)$ | $7^{\circ} \mathrm{C} / \mathrm{W}$ |
| Junction to Case $\left(\theta_{\mathrm{JC}}\right)$ |  |

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a " + ", "\#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

## Electrical Characteristics

$\left(\mathrm{V}_{\mathbb{I N}}=12 \mathrm{~V}\right.$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\mathrm{IN}}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\text {DITHER/SYNC }}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=\mathrm{V}_{\mathrm{GND}}$, $V_{E N}=+2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{IN}}=1 \mu \mathrm{~F}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}(\mathrm{MAX} 5974 \mathrm{BETE}+$, MAX5974CETE + , MAX5974DETE + ), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ (MAX5974AETE + ), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (MAX5974AATE + , MAX5974BATE + , MAX5974CATE + , MAX5974DATE + ), unless otherwise noted. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)


Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## Electrical Characteristics (continued)

( $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\mathrm{IN}}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\text {DITHER/SYNC }}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=\mathrm{V}_{\mathrm{GND}}$, $V_{E N}=+2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega, \mathrm{C}_{\text {IN }}=1 \mu \mathrm{~F}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}(\mathrm{MAX} 5974 \mathrm{BETE}+$, MAX5974CETE + , MAX5974DETE + ), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ (MAX5974AETE + ), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (MAX5974AATE + , MAX5974BATE + , MAX5974CATE + , MAX5974DATE + ), unless otherwise noted. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Duty Cycle During Synchronization |  |  |  | $\mathrm{D}_{\text {MAX }} \times \mathrm{f}_{\mathrm{SYNC}} /$$\mathrm{f}_{\mathrm{SW}}$ |  |  | \% |
| DITHERING RAMP GENERATOR (DITHER) |  |  |  |  |  |  |  |
| Charging Current |  | $\mathrm{V}_{\text {DITHER }}=0 \mathrm{~V}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 45 | 50 | 55 | $\mu \mathrm{A}$ |
|  |  |  | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 44.5 | 50 | 55.5 |  |
| Discharging Current |  | $\mathrm{V}_{\text {DITHER }}=2.2 \mathrm{~V}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 43 | 50 | 57 | $\mu \mathrm{A}$ |
|  |  |  | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 42 | 50 | 58 |  |
| Ramp's High Trip Point |  |  |  |  | 2 |  | V |
| Ramp's Low Trip Point |  |  |  |  | 0.4 |  | V |
| SOFT-START AND RESTART (SS) |  |  |  |  |  |  |  |
| Charging Current | ISS-CH | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 9.5 | 10 | 10.5 | $\mu \mathrm{A}$ |
|  |  | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  | 9 | 10 | 11 |  |
| Discharging Current | ISS-D | $\mathrm{V}_{\text {SS }}=2 \mathrm{~V}$, normal shutdown |  | 0.65 | 1.34 | 2 | mA |
|  | ISS-DH | $\left(\mathrm{V}_{\mathrm{EN}}<\mathrm{V}_{\mathrm{ENF}}\right.$ or $\left.\mathrm{V}_{\text {IN }}<\mathrm{V}_{\text {INUVF }}\right)$, <br> $\mathrm{V}_{\mathrm{SS}}=2 \mathrm{~V}$, hiccup mode discharge for tRSTRT (Note 2) |  | 1.6 | 2 | 2.4 | $\mu \mathrm{A}$ |
| Discharge Threshold to Disable Hiccup and Restart | $V_{\text {SS-DTH }}$ |  |  | 0.15 |  |  | V |
| Minimum Restart Time During Hiccup Mode | ${ }^{\text {tr }}$ STRT-MIN |  |  | 1024 |  |  | Clock Cycles |
| Normal Operating High Voltage | $\mathrm{V}_{\text {SS-HI }}$ |  |  |  | 5 |  | V |
| Duty-Cycle Control Range | $\mathrm{V}_{\text {SS-DMAX }}$ | $\mathrm{D}_{\text {MAX }}(\mathrm{typ})=\left(\mathrm{V}_{\text {SS-DMAX }} / 2.43 \mathrm{~V}\right)$ |  | 0 |  | 2 | V |
| DUTY-CYCLE CLAMP (DCLMP) |  |  |  |  |  |  |  |
| DCLMP Input Current | IDCLMP | $\mathrm{V}_{\text {DCLMP }}=0$ to 5 V |  | -100 | 0 | +100 | nA |
| Duty-Cycle Control Range | $\mathrm{V}_{\text {DCLMP-R }}$ |  | $\mathrm{V}_{\text {DCLMP }}=0.5 \mathrm{~V}$ | 73 | 75.4 | 77.5 | \% |
|  |  | $\begin{aligned} & \mathrm{D}_{\mathrm{MAX}}(\text { typ })= \\ & 1-\left(\mathrm{V}_{\mathrm{DCLMP}} / 2.43 \mathrm{~V}\right) \end{aligned}$ | $\mathrm{V}_{\text {DCLMP }}=1 \mathrm{~V}$ | 54 | 56 | 58 |  |
|  |  |  | $\mathrm{V}_{\text {DCLMP }}=2 \mathrm{~V}$ | 14.7 | 16.5 | 18.3 |  |
| NDRV DRIVER |  |  |  |  |  |  |  |
| Pulldown Impedance | RNDRV-N | $\begin{aligned} & I_{\text {NDRV }}(\text { sinking })= \\ & 100 \mathrm{~mA} \end{aligned}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 1.9 | 3.4 | $\Omega$ |
|  |  |  | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  | 1.9 | 3.5 |  |
| Pullup Impedance | $\mathrm{R}_{\text {NDRV-P }}$ | $\mathrm{I}_{\text {NDRV }}$ (sourcing) $=50 \mathrm{~mA}$ |  |  | 4.7 | 8.3 | $\Omega$ |
| Peak Sink Current |  |  |  | 1 |  |  | A |
| Peak Source Current |  |  |  | 0.65 |  |  | A |
| Fall Time | $\mathrm{t}_{\text {NDRV-F }}$ | $\mathrm{C}_{\text {NDRV }}=1 \mathrm{nF}$ |  | 14 |  |  | ns |
| Rise Time | $\mathrm{t}_{\text {NDRV-R }}$ | $\mathrm{C}_{\text {NDRV }}=1 \mathrm{nF}$ |  | 27 |  |  | ns |
| AUXDRV DRIVER |  |  |  |  |  |  |  |
| Pulldown Impedance | $\mathrm{R}_{\text {AUX-N }}$ | $\begin{aligned} & \mathrm{I}_{\text {AUXDRV }}(\text { sinking })= \\ & 50 \mathrm{~mA} \end{aligned}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | 4.3 | 7.7 | $\Omega$ |
|  |  |  | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  | 4.3 | 7.95 |  |
| Pullup Impedance | $\mathrm{R}_{\text {AUX-P }}$ | $\mathrm{I}_{\text {AUXDRV ( }}$ (sourcing) $=25 \mathrm{~mA}$ |  |  | 10.6 | 18.9 | $\Omega$ |

## Electrical Characteristics (continued)

( $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\mathrm{IN}}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\text {DITHER/SYNC }}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=\mathrm{V}_{\mathrm{GND}}$, $V_{E N}=+2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{IN}}=1 \mu \mathrm{~F}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}(\mathrm{MAX} 5974 \mathrm{BETE}+$, MAX5974CETE + , MAX5974DETE + ), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ (MAX5974AETE + ), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}($ MAX5974AATE + , MAX5974BATE,+ MAX5974CATE + , MAX5974DATE + ), unless otherwise noted. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)


## Electrical Characteristics (continued)

( $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\mathrm{IN}}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\text {DITHER/SYNC }}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=\mathrm{V}_{\mathrm{GND}}$, $V_{E N}=+2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{IN}}=1 \mu \mathrm{~F}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}(\mathrm{MAX} 5974 \mathrm{BETE}+$, MAX5974CETE + , MAX5974DETE + ), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ (MAX5974AETE + ), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (MAX5974AATE + , MAX5974BATE + , MAX5974CATE + , MAX5974DATE + ), unless otherwise noted. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Note 1)


Note 1: All devices are $100 \%$ production tested at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Limits over temperature are guaranteed by design.
Note 2: See the Output Short-Circuit Protection with Hiccup Mode section.
Note 3: The parameter is measured at the trip point of latch with $\mathrm{V}_{\mathrm{FB}}=0 \mathrm{~V}$. Gain is defined as $\Delta \mathrm{V}_{\text {COMP }} / \Delta \mathrm{V}_{\mathrm{CSSC}}$ for $0.15 \mathrm{~V}<$ $\Delta \mathrm{V}_{\text {Cssc }}<0.25 \mathrm{~V}$.
Note 4: Operates over the $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ operating temperature range.

## Typical Operating Characteristics

( $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\text {IN }}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\mathrm{DITHER} / \mathrm{SYNC}}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=$ $\mathrm{V}_{\mathrm{GND}}, \mathrm{V}_{\mathrm{EN}}=2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega$, unless otherwise noted.)


Typical Operating Characteristics (continued)
( $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\text {IN }}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\mathrm{DITHER} / \mathrm{SYNC}}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=$ $\mathrm{V}_{\mathrm{GND}}, \mathrm{V}_{\mathrm{EN}}=2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega$, unless otherwise noted.)


Typical Operating Characteristics (continued)
$\left(\mathrm{V}_{\text {IN }}=12 \mathrm{~V}\right.$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\text {IN }}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\text {DITHER/SYNC }}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=$ $\mathrm{V}_{\mathrm{GND}}, \mathrm{V}_{\mathrm{EN}}=2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega$, unless otherwise noted.)


Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

Typical Operating Characteristics (continued)
$\left(\mathrm{V}_{\text {IN }}=12 \mathrm{~V}\right.$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\text {IN }}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\text {DITHER/SYNC }}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=$ $\mathrm{V}_{\mathrm{GND}}, \mathrm{V}_{\mathrm{EN}}=2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega$, unless otherwise noted.)


## Active-Clamped, Spread-Spectrum,

 Current-Mode PWM Controllers
## Typical Operating Characteristics (continued)

( $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ (for MAX5974A/MAX5974C, bring $\mathrm{V}_{\text {IN }}$ up to 17 V for startup), $\mathrm{V}_{\mathrm{CS}}=\mathrm{V}_{\mathrm{CSSC}}=\mathrm{V}_{\mathrm{DITHER} / \mathrm{SYNC}}=\mathrm{V}_{\mathrm{FB}}=\mathrm{V}_{\mathrm{FFB}}=\mathrm{V}_{\mathrm{DCLMP}}=$ $\mathrm{V}_{\mathrm{GND}}, \mathrm{V}_{\mathrm{EN}}=2 \mathrm{~V}, \mathrm{NDRV}=\mathrm{AUXDRV}=\mathrm{SS}=\mathrm{COMP}=$ unconnected, $\mathrm{R}_{\mathrm{RT}}=34.8 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{DT}}=25 \mathrm{k} \Omega$, unless otherwise noted.)


Pin Configuration


## Pin Description

| PIN | NAME | FUNCTION |
| :---: | :---: | :--- |
| 1 | DT | Dead-Time Programming Resistor Connection. Connect resistor R RT from DT to GND to set the <br> desired dead time between the NDRV and AUXDRV signals. See the Dead Time section to calculate <br> the resistor value for a particular dead time. |
| 2 | DITHER/ <br> SYNC | Frequency Dithering Programming or Synchronization Connection. For spread-spectrum frequency <br> operation, connect a capacitor from DITHER to GND and a resistor from DITHER to RT. To <br> synchronize the internal oscillator to the externally applied frequency, connect DITHER/SYNC to the <br> synchronization pulse. |
| 3 | RT | Switching Frequency Programming Resistor Connection. Connect resistor R RT from RT to GND to set <br> the PWM switching frequency. See the Oscillator/Switching Frequency section to calculate the resistor <br> value for the desired oscillator frequency. |
| 4 | FFB | Frequency Foldback Threshold Programming Input. Connect a resistor from FFB to GND to set the <br> output average current threshold below which the converter folds back the switching frequency to $1 / 2$ <br> of its original value. Connect to GND to disable frequency foldback. |
| 5 | COMP | Transconductance Amplifier Output and PWM Comparator Input. COMP is level shifted down and <br> connected to the inverting input of the PWM comparator. COMP is actively pulled low by the controller <br> after shutdown. |

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## Pin Description (continued)

| PIN | NAME | FUNCTION |
| :---: | :---: | :---: |
| 6 | FB | Transconductance Amplifier Inverting Input |
| 7 | GND | Signal Ground |
| 8 | CSSC | Current Sense with Slope Compensation Input. A resistor connected from CSSC to CS programs the amount of slope compensation. See the Programmable Slope Compensation section. |
| 9 | CS | Current-Sense Input. Current-sense connection for average current sense and cycle-by-cycle current limit. Peak current-limit trip voltage is 400 mV and reverse current-limit trip voltage is -100 mV . |
| 10 | PGND | Power Ground. PGND is the return path for gate-driver switching currents. |
| 11 | NDRV | Main Switch Gate-Driver Output |
| 12 | AUXDRV | pMOS Active Clamp Switch Gate-Driver Output. AUXDRV can also be used to drive a pulse transformer for synchronous flyback application. |
| 13 | IN | Converter Supply Input. IN has wide UVLO hysteresis, enabling the design of efficient power supplies. See the Enable Input section to determine if an external zener diode is required at IN. |
| 14 | EN | Enable Input. The gate drivers are disabled and the device is in a low-power UVLO mode when the voltage on EN is below $\mathrm{V}_{\mathrm{ENF}}$. When the voltage on EN is above $\mathrm{V}_{E N R}$, the device checks for other enable conditions. See the Enable Input section for more information about interfacing to EN. |
| 15 | DCLMP | Feed-Forward Maximum Duty-Cycle Clamp Programming Input. Connect a resistive divider between the input supply voltage DCLMP and GND. The voltage at DCLMP sets the maximum duty cycle ( $\mathrm{D}_{\text {MAX }}$ ) of the converter inversely proportional to the input supply voltage, so that the MOSFET remains protected during line transients. |
| 16 | SS | Soft-Start Programming Capacitor Connection. Connect a capacitor from SS to GND to program the soft-start period. This capacitor also determines hiccup mode current-limit restart time. A resistor from SS to GND can also be used to set the $\mathrm{D}_{\text {MAX }}$ below $75 \%$. |
| - | EP | Exposed Pad. Internally connected to GND. Connect to a large ground plane to maximize thermal performance. Not intended as an electrical connection point. |

## Block Diagrams



Block Diagrams (continued)


## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## Detailed Description

The MAX5974A/MAX5974B/MAX5974C/MAX5974D are optimized for controlling a 25 W to 50 W active-clamped, self-driven synchronous rectification forward converter in continuous-conduction mode. The main switch gate driver (NDRV) and the active-clamped switch driver (AUXDRV) are sized to optimize efficiency for 25 W design. The features-rich devices are ideal for PoE IEEE 802.3af/atpowered devices.
The MAX5974A/MAX5974C offer a 16V bootstrap UVLO wake-up level with a 9 V wide hysteresis. The low startup and operating currents allow the use of a smaller storage capacitor at the input without compromising startup and hold times. The MAX5974A/MAX5974C are well-suited for universal input (rectified 85V AC to 265 V AC) or telecom (-36V DC to -72V DC) power supplies.
The MAX5974B/MAX5974D have a UVLO rising threshold of 8.4 V and can accommodate for low-input voltage ( 12 V DC to 24 V DC) power sources such as wall adapters.
Power supplies designed with the MAX5974A/MAX5974C use a high-value startup resistor, $\mathrm{R}_{\mathrm{IN}}$, that charges a reservoir capacitor, $\mathrm{C}_{\mathrm{IN}}$ (see the Typical Application Circuits). During this initial period, while the voltage is less than the internal bootstrap UVLO threshold, the device typically consumes only $100 \mu \mathrm{~A}$ of quiescent current. This low startup current and the large bootstrap UVLO hysteresis help to minimize the power dissipation across $R_{I N}$ even at the high end of the universal AC input voltage ( 265 V AC).
Feed-forward maximum duty-cycle clamping detects changes in line conditions and adjusts the maximum duty cycle accordingly to eliminate the clamp voltage's (i.e., the main power FET's drain voltage) dependence on the input voltage.
For EMI-sensitive applications, the programmable frequency dithering feature allows up to $\pm 10 \%$ variation in the switching frequency. This spread-spectrum modulation technique spreads the energy of switching harmonics over a wider band while reducing their peaks, helping to meet stringent EMI goals.

The devices include a cycle-by-cycle current limit that turns off the main and AUX drivers whenever the internally set threshold of 400 mV is exceeded. Eight consecutive occurrences of current-limit events trigger hiccup mode, which protects external components by halting switching for a period of time (tRSTRT) and allowing the overload current to dissipate in the load and body diode of the synchronous rectifier before soft-start is reattempted.
The reverse current-limit feature of the devices turns the AUX driver off for the remaining off period when $\mathrm{V}_{\mathrm{CS}}$ exceeds the -100 mV threshold. This protects the transformer core from saturation due to excess reverse current under some extreme transient conditions.

## Current-Mode Control Loop

The advantages of current-mode control over voltagemode control are twofold. First, there is the feed-forward characteristic brought on by the controller's ability to adjust for variations in the input voltage on a cycle-bycycle basis. Second, the stability requirements of the cur-rent-mode controller are reduced to that of a single-pole system, unlike the double pole in voltage-mode control.
The devices use a current-mode control loop where the scaled output of the error amplifier (COMP) is compared to a slope-compensated current-sense signal at CSSC.

## Input Clamp

When the device is enabled, an internal 18 V input clamp is active. During an overvoltage condition, the clamp prevents the voltage at the supply input IN from rising above 18.5V (typ).

When the device is disabled, the input clamp circuitry is also disabled.

## Enable Input

The enable input is used to enable or disable the device. Driving EN low disables the device. Note that the internal 18 V input clamp is also disabled when EN is low. Therefore, an external 18 V zener diode is needed for certain operating conditions as described below.

## UVLO on Power Source

The enable input has an accurate threshold of 1.26 V (max). For applications that require a UVLO on the power source, connect a resistive divider from the power source to EN to GND as shown in Figure 1. A zener diode between IN and GND is required to prevent the NDRV and AUXDRV gate-drive voltages from exceeding 20V, the maximum allowed gate voltage of power FETs.
The external zener diode should clamp in the following range:

$$
20 \mathrm{~V}>\mathrm{V}_{\mathrm{Z}}>\mathrm{V}_{\mathrm{UVLO}}(\mathrm{MAX})
$$

where $V_{Z}$ is the zener voltage and $V_{U V L O}(M A X)$ is the maximum wakeup level ( 16.5 V or 8.85 V depending on the device version). An 18 V zener diode is the best choice.
Design the resistive divider by first selecting the value of $R_{\text {EN } 1}$ to be on the order of $100 \mathrm{k} \Omega$. Then calculate $\mathrm{R}_{\mathrm{EN} 2}$ as follows:

$$
V_{E N 2}=R_{E N 1} \times \frac{V_{E N(M A X)}}{V_{S(U V L O)}-V_{E N(M A X)}}
$$

where $\mathrm{V}_{\mathrm{EN}(\mathrm{MAX})}$ is the maximum enable threshold voltage and is equal to 1.26 V and $\mathrm{V}_{\mathrm{S}}$ (UVLO) is the desired UVLO threshold for the power source, below which the device is disabled.


Figure 1. Programmable UVLO for the Power Source

The digital output connected to EN should be capable of withstanding more than the maximum supply voltage.

## MCU Control of Enable Input

When using a microcontroller GPIO to control the enable input, an 18 V zener diode is required on IN as shown in Figure 2.

## High-Voltage Logic Control of Enable Input

In the case where EN is externally controlled by a highvoltage open-drain/collector output (e.g., PGOOD indicator of a powered device controller), connect IN to EN through a resistor $\mathrm{R}_{\mathrm{EN}}$ and connect EN to an open-drain or open-collector output as shown in Figure 3. Select $\mathrm{R}_{\mathrm{EN}}$ such that the voltage at IN , when EN is low, is less than 20 V (i.e., the maximum gate voltage of the main and AUX FETs):

$$
V_{S(M A X)} \times \frac{R_{E N}}{R_{E N}+R_{I N}}<20 \mathrm{~V}
$$

where $\mathrm{V}_{\mathrm{S}(\text { MAX })}$ is the maximum supply voltage. Obeying this relationship eliminates the need for an external zener diode.
The digital output connected to EN should be capable of withstanding more than 20V.


Figure 2. MCU Control of the Enable Input

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

Because the MAX5974B/MAX5974D are designed for use with low-voltage power sources such as wall adapters outputting 12 V to 24 V , they have a lower UVLO wake-up threshold of 8.4 V .

## Startup Operation

The device starts up when the voltage at IN exceeds 16 V (MAX5974A/MAX5974C) or 8.4V (MAX5974B/MAX5974D) and the enable input voltage is greater than 1.26 V .
During normal operation, the voltage at IN is normally derived from a tertiary winding of the transformer (MAX5974C/MAX5974D). However, at startup there is no energy being delivered through the transformer; hence, a special bootstrap sequence is required. In the Typical Application Circuits, $\mathrm{C}_{\mathrm{IN}}$ charges through the startup resistor, $\mathrm{R}_{\mathrm{IN}}$, to an intermediate voltage. Only $100 \mu \mathrm{~A}$ of the current supplied through $\mathrm{R}_{\mathrm{IN}}$ is used by the ICs, the remaining input current charges $\mathrm{C}_{\mathrm{IN}}$ until $\mathrm{V}_{\mathrm{IN}}$ reaches the bootstrap UVLO wake-up level. Once $\mathrm{V}_{\mathrm{IN}}$ exceeds this level, NDRV begins switching the n-channel MOSFET and transfers energy to the secondary and tertiary outputs. If the voltage on the tertiary output builds to higher than 7 V (the bootstrap UVLO shutdown level), then startup has been accomplished and sustained operation commences. If $\mathrm{V}_{\text {IN }}$ drops below 7 V before startup is complete, the device goes back to low-current UVLO. In this case, increase the value of $\mathrm{C}_{\mathrm{IN}}$ in order to store enough energy to allow for the voltage at the tertiary winding to build up.
While the MAX5974A/MAX5974B derive their input voltage from the coupled inductor output during normal operation, the startup behavior is similar to that of the MAX5974C/MAX5974D.

## Soft-Start

A capacitor from SS to GND, CSS, programs the soft-start time. $\mathrm{V}_{\mathrm{SS}}$ controls the oscillator duty cycle during startup to provide a slow and smooth increase of the duty cycle to its steady-state value. Calculate the value of $\mathrm{C}_{\mathrm{SS}}$ as follows:

$$
\mathrm{C}_{\mathrm{SS}}=\frac{\mathrm{ISS}-\mathrm{CH} \times \mathrm{t}_{\mathrm{SS}}}{2 \mathrm{~V}}
$$

where $\mathrm{I}_{\mathrm{SS}-\mathrm{CH}}\left(10 \mu \mathrm{~A}\right.$ typ) is the current charging $\mathrm{C}_{\mathrm{SS}}$ during soft-start and tss is the programmed soft-start time.
A resistor can also be added from the SS pin to GND to clamp $\mathrm{V}_{\mathrm{SS}}<2 \mathrm{~V}$ and, hence, program the maximum duty cycle to be less than $80 \%$ (see the Duty-Cycle Clamping section)

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## n-Channel MOSFET Gate Driver

The NDRV output drives an external n-channel MOSFET. NDRV can source/sink in excess of $650 \mathrm{~mA} / 1000 \mathrm{~mA}$ peak current; therefore, select a MOSFET that yields acceptable conduction and switching losses. The external MOSFET used must be able to withstand the maximum clamp voltage.

## p-Channel MOSFET Gate Driver

The AUXDRV output drives an external p-channel MOSFET with the aid of a level shifter. The level shifter consists of $\mathrm{C}_{A U X}, \mathrm{R}_{\mathrm{AUX}}$, and D5 as shown in the Typical Application Circuits. When AUXDRV is high, CAUX is recharged through D5. When AUXDRV is low, the gate of the p-channel MOSFET is pulled below the source by the voltage stored on $\mathrm{C}_{\mathrm{AUX}}$, turning on the pFET .
Add a zener diode between gate to source of the external n-channel and p-channel MOSFETs after the gate resistors to protect $\mathrm{V}_{\mathrm{GS}}$ from rising above its absolute maximum rating during transient condition (see the Typical Application Circuits).

## Dead Time

Dead time between the main and AUX output edges allow ZVS to occur, minimizing conduction losses and improving efficiency. The dead time ( $t_{D T}$ ) is applied to both leading and trailing edges of the main and AUX outputs as shown in Figure 5. Connect a resistor between DT and GND to set $t_{D T}$ to any value between 40 ns and 400ns:

$$
\mathrm{R}_{\mathrm{DT}}=\frac{10 \mathrm{k} \Omega}{40 \mathrm{~ns}} \times \mathrm{t}_{\mathrm{DT}}
$$

## Oscillator/Switching Frequency

The ICs' switching frequency is programmable between 100 kHz and 600 kHz with a resistor $\mathrm{R}_{\mathrm{RT}}$ connected between RT and GND. Use the following formula to determine the appropriate value of $R_{R T}$ needed to generate the desired output-switching frequency (fsw):

$$
\mathrm{R}_{\mathrm{RT}}=\frac{8.7 \times 10^{9}}{\mathrm{f}_{\mathrm{SW}}}
$$

where $f_{S W}$ is the desired switching frequency.


Figure 5. Dead Time Between AUXDRV and NDRV

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## Peak Current Limit

The current-sense resistor ( $\mathrm{R}_{\mathrm{CS}}$ in the Typical Application Circuits), connected between the source of the $n$-channel MOSFET and PGND, sets the current limit. The currentlimit comparator has a voltage trip level ( $\mathrm{V}_{\text {CS-PEAK }}$ ) of 400 mV . Use the following equation to calculate the value of $\mathrm{R}_{\mathrm{CS}}$ :

$$
\mathrm{R}_{\mathrm{CS}}=\frac{400 \mathrm{mV}}{\mathrm{I}_{\mathrm{PRI}}}
$$

where IPRI is the peak current in the primary side of the transformer, which also flows through the MOSFET. When the voltage produced by this current (through the currentsense resistor) exceeds the current-limit comparator threshold, the MOSFET driver (NDRV) terminates the current on-cycle, within 35 ns (typ).
The devices implement 115ns of leading-edge blanking to ignore leading-edge current spikes. These spikes are caused by reflected secondary currents, current-discharging capacitance at the FET's drain, and gate-charging current. Use a small RC network for additional filtering of the leading-edge spike on the sense waveform when needed. Set the corner frequency between 10 MHz and 20 MHz .
After the leading-edge blanking time, the device monitors $V_{\text {Cs }}$ for any breaches of the peak current limit of 400 mV . The duty cycle is terminated immediately when $V_{\text {CS }}$ exceeds 400 mV .

## Reverse Current Limit

The devices protect the transformer against saturation due to reverse current by monitoring the voltage across $R_{\text {CS }}$ while the AUX output is low and the p-channel FET is on.

## Output Short-Circuit Protection with Hiccup Mode

When the device detects eight consecutive peak currentlimit events, both NDRV and AUXDRV driver outputs are turned off for a restart period, tRSTRT. After $t_{\text {RSTRT, }}$ the device undergoes soft-start. The duration of the restart period depends on the value of the capacitor at $\mathrm{SS}\left(\mathrm{C}_{S S}\right)$. During this period, $\mathrm{C}_{S S}$ is discharged with a pulldown current of $I_{S S}-D H(2 \mu \mathrm{~A}$ typ $)$. Once its voltage reaches 0.15 V , the restart period ends and the device initiates a soft-start sequence. An internal counter ensures that the minimum restart period (tRSTRT-MIN) is 1024 clock cycles when the time required for $\mathrm{C}_{\mathrm{SS}}$ to discharge to 0.15 V is less than 1024 clock cycles. Figure 6 shows the behavior of the device prior and during hiccup mode.

## Frequency Foldback for High-Efficiency Light-Load Operation

The frequency foldback threshold can be programmed from 0 to $20 \%$ of the full load current using a resistor from FFB to GND.


Figure 6. Hiccup Mode Timing Diagram

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

When $V_{\text {CSAVG }}$ falls below $V_{\text {FFB }}$, the device folds back the switching frequency to $1 / 2$ the original value to reduce switching losses and increase the converter efficiency. Calculate the value of $R_{\text {FFB }}$ as follows:

where RFFB is the resistor between FFB and GND, lLOAD(LIGHT) is the current at light-load conditions that triggers frequency foldback, $R_{C S}$ is the value of the sense resistor connected between CS and PGND, and IFFB is the current sourced from FFB to RFFB ( $30 \mu \mathrm{~A}$ typ).

## Duty-Cycle Clamping

The maximum duty cycle is determined by the lowest of three voltages: 2 V , the voltage at $\mathrm{SS}\left(\mathrm{V}_{\mathrm{SS}}\right)$, and the voltage ( 2.43 V - $\mathrm{V}_{\mathrm{DCLMP}}$ ). The maximum duty cycle is calculated as:

$$
\mathrm{D}_{\mathrm{MAX}}=\frac{\mathrm{V}_{\mathrm{MIN}}}{2.43 \mathrm{~V}}
$$

where $\mathrm{V}_{\mathrm{MIN}}=$ minimum $\left(2 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}, 2.43 \mathrm{~V}-\mathrm{V}_{\mathrm{DCLMP}}\right)$.

## SS

By connecting a resistor between SS and ground, the voltage at SS can be made to be lower than 2 V . $\mathrm{V}_{\mathrm{SS}}$ is calculated as follows:

$$
V_{S S}=R_{S S} \times I_{S S}-C H
$$

where $R_{S S}$ is the resistor connected between $S S$ and GND, and $I_{S S}-C H$ is the current sourced from $S S$ to $R_{S S}$ ( $10 \mu \mathrm{~A}$ typ).

## DCLMP

To set $\mathrm{D}_{\mathrm{MAX}}$ using supply voltage feed-forward, connect a resistive divider between the supply voltage, DCLMP, and GND as shown in the Typical Application Circuits. This feed-forward duty-cycle clamp ensures that the external n-channel MOSFET is not stressed during supply transients. $V_{\text {DCLMP }}$ is calculated as follows:

$$
\mathrm{V}_{\mathrm{DCLMP}}=\frac{\mathrm{R}_{\mathrm{DCLMP}}}{\mathrm{R}_{\mathrm{DCLMP} 1}+\mathrm{R}_{\mathrm{DCLMP}}} \times \mathrm{V}_{\mathrm{S}}
$$

where $\mathrm{R}_{\mathrm{DCLMP}}$ 1 and $\mathrm{R}_{\text {DCLMP2 }}$ are the resistive divider values shown in the Typical Application Circuits and $\mathrm{V}_{\mathrm{S}}$ is the input supply voltage.

## Oscillator Synchronization

The internal oscillator can be synchronized to an external clock by applying the clock to DITHER/SYNC directly. The external clock frequency can be set anywhere between $1.1 x$ to $2 x$ the internal clock frequency.
Using an external clock increases the maximum duty cycle by a factor equal to fSYNC/fSW. This factor should be accounted for in setting the maximum duty cycle using any of the methods described in the Duty-Cycle Clamping section. The formula below shows how the maximum duty cycle is affected by the external clock frequency:

$$
\mathrm{D}_{\mathrm{MAX}}=\frac{\mathrm{V}_{\mathrm{MIN}}}{2.43 \mathrm{~V}} \times \frac{\mathrm{f}_{\mathrm{SYNC}}}{f_{\mathrm{SW}}}
$$

where $\mathrm{V}_{\mathrm{MIN}}$ is described in the Duty-Cycle Clamping section, fSW is the switching frequency as set by the resistor connected between RT and GND, and fSYNC is the external clock frequency.

## Frequency Dithering for SpreadSpectrum Applications (Low EMI)

The switching frequency of the converter can be dithered in a range of $\pm 10 \%$ by connecting a capacitor from DITHER/SYNC to GND, and a resistor from DITHER/ SYNC to RT as shown in the Typical Application Circuits. This results in lower EMI.
A current source at DITHER/SYNC charges the capacitor $C_{\text {DITHER }}$ to 2 V at $50 \mu \mathrm{~A}$. Upon reaching this trip point, it discharges $\mathrm{C}_{\text {DITHER }}$ to 0.4 V at $50 \mu \mathrm{~A}$. The charging and discharging of the capacitor generates a triangular waveform on DITHER/SYNC with peak levels at 0.4 V and 2 V and a frequency that is equal to:

$$
\mathrm{f}_{\mathrm{TRI}}=\frac{50 \mu \mathrm{~A}}{\mathrm{C}_{\text {DITHER }} \times 3.2 \mathrm{~V}}
$$

Typically, $\mathrm{f}_{\text {TRI }}$ should be set close to 1 kHz . The resistor RDITHER connected from DITHER/SYNC to RT determines the amount of dither as follows:

$$
\% \text { DITHER }=\frac{4}{3} \times \frac{R_{\text {RT }}}{R_{\text {DITHER }}}
$$

where \%DITHER is the amount of dither expressed as a percentage of the switching frequency. Setting RDITHER to $10 \times R_{R T}$ generates $\pm 10 \%$ dither.

## MAX5974A/MAX5974B/ MAX5974C/MAX5974D

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## Programmable Slope Compensation

The device generates a current ramp at CSSC such that its peak is $50 \mu \mathrm{~A}$ at $80 \%$ duty cycle of the oscillator. An external resistor connected from CSSC to the CS then converts this current ramp into programmable slopecompensation amplitude, which is added to the currentsense signal for stability of the peak current-mode control loop. The ramp rate of the slope compensation signal is given by:

$$
m=\frac{R_{C S S C} \times 50 \mu A \times f}{80 \%}
$$

where m is the ramp rate of the slope-compensation signal, $\mathrm{R}_{\mathrm{Cssc}}$ is the value of the resistor connected between CSSC and CS used to program the ramp rate, and fSW is the switching frequency.

## Error Amplifier

The MAX5974A/MAX5974B include an internal error amplifier with a sample-and-hold input. The feedback input of the MAX5974C/MAX5974D is continuously connected. The noninverting input of the error amplifier is connected to the internal reference and feedback is provided at the inverting input. High open-loop gain and unity-gain bandwidth allow good closed-loop bandwidth and transient response. Calculate the power-supply output voltage using the following equation:

$$
V_{\mathrm{OUT}}=\mathrm{V}_{\mathrm{REF}} \times \frac{R_{\mathrm{FB} 1}+R_{\mathrm{FB} 2}}{R_{\mathrm{FB} 2}}
$$

where $\mathrm{V}_{\text {REF }}=1.52 \mathrm{~V}$ for the MAX5974A/MAX5974B and $V_{\text {REF }}=1.215 \mathrm{~V}$ for the MAX5974C/MAX5974D. The amplifier's noninverting input is internally connected to a soft-start circuit that gradually increases the reference voltage during startup. This forces the output voltage to come up in an orderly and well-defined manner under all load conditions.

## Applications Information

## Startup Time Considerations

The bypass capacitor at $\mathrm{IN}, \mathrm{C}_{\mathrm{IN}}$, supplies current immediately after the devices wake up (see the Typical

Application Circuits). Large values of $\mathrm{C}_{\mathrm{IN}}$ increase the startup time, but also supply gate charge for more cycles during initial startup. If the value of $\mathrm{C}_{\mathrm{IN}}$ is too small, $\mathrm{V}_{\mathrm{IN}}$ drops below 7 V because NDRV does not have enough time to switch and build up sufficient voltage across the tertiary output (MAX5974C/MAX5974D) or coupled inductor output (MAX5974A/MAX5974B), which powers the device. The device goes back into UVLO and does not start. Use a low-leakage capacitor for $\mathrm{C}_{\mathrm{IN}}$.
Typically, offline power supplies keep startup times to less than 500 ms even in low-line conditions ( 85 V AC input for universal offline or 36 V DC for telecom applications). Size the startup resistor, $\mathrm{R}_{\mathrm{IN}}$, to supply both the maximum startup bias of the device $(150 \mu \mathrm{~A})$ and the charging current for $\mathrm{C}_{\mathrm{IN}}$. $\mathrm{C}_{\mathrm{IN}}$ must be charged to 16 V within the desired 500 ms time period. $\mathrm{C}_{\mathrm{IN}}$ must store enough charge to deliver current to the device for at least the soft-start time (tss) set by Css. To calculate the approximate amount of capacitance required, use the following formula:

$$
\begin{gathered}
\mathrm{I}_{\mathrm{G}}=\mathrm{Q}_{\mathrm{GTOT}} \mathrm{f}_{\mathrm{SW}} \\
\mathrm{C}_{\mathrm{IN}}=\frac{\left(\mathrm{I}_{\mathrm{IN}}+\mathrm{I}_{\mathrm{G}}\right)\left(\mathrm{t}_{\mathrm{SS}}\right)}{\mathrm{V}_{\mathrm{HYST}}}
\end{gathered}
$$

where $\mathrm{I}_{\mathrm{N}}$ is the ICs' internal supply current $(1.8 \mathrm{~mA})$ after startup, $Q_{\text {GTOT }}$ is the total gate charge for the $n$-channel and p-channel FETs, fsw is the ICs' switching frequency, $\mathrm{V}_{\text {HYST }}$ is the bootstrap UVLO hysteresis ( 9 V typ), and tss is the soft-start time. RIN is then calculated as follows:

$$
\mathrm{R}_{\mathrm{IN}} \cong \frac{\mathrm{~V}_{\mathrm{S}(\mathrm{MIN})}-\mathrm{V}_{\mathrm{INUVR}}}{I_{\mathrm{START}}}
$$

where $\mathrm{V}_{\text {S(MIN) }}$ is the minimum input supply voltage for the application ( 36 V for telecom), $\mathrm{V}_{\text {INUVR }}$ is the bootstrap UVLO wake-up level ( 16 V ), and ISTART is the IN supply current at startup ( $150 \mu \mathrm{~A}$ max).
$\mathrm{R}_{\mathrm{IN}}$ needs to be reduced when operating at $+125^{\circ} \mathrm{C}$ ambient temperature since the $\operatorname{IN}$ supply current is increased.
Choose a higher value for $\mathrm{R}_{\mathrm{IN}}$ than the one calculated above if a longer startup time can be tolerated in order to minimize power loss on this resistor.

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## Active Clamp Circuit

Traditional clamp circuits prevent transformer saturation by channeling the magnetizing current ( $\mathrm{I}_{\mathrm{M}}$ ) of the transformer onto a dissipative RC network. To improve efficiency, the active clamp circuit recycles $I_{M}$ between the magnetizing inductance and clamp capacitor. $\mathrm{V}_{\text {CLAMP }}$ is given by:

$$
\mathrm{V}_{\mathrm{CLAMP}}=\frac{\mathrm{V}_{\mathrm{S}}}{1-\mathrm{D}}
$$

where $\mathrm{V}_{\mathrm{S}}$ is the voltage of the power source and D is the duty cycle. To select $n$-channel and $p$-channel FETs with adequate breakdown voltages, use the maximum value of $\mathrm{V}_{\text {CLAMP. }} \mathrm{V}_{\text {CLAMP }}$ (MAX) occurs when the input voltage is at its minimum and the duty cycle is at its maximum. $\mathrm{V}_{\text {CLAMP(MAX-NORMAL) }}$ during normal operation is therefore:

$$
\mathrm{V}_{\mathrm{CLAMP}(\mathrm{MAX}-\mathrm{NORMAL})}=\frac{\mathrm{V}_{\mathrm{S}(\mathrm{MIN})}}{1-\frac{\mathrm{N}_{\mathrm{P}} \times \mathrm{V}_{\mathrm{O}}}{\mathrm{~N}_{\mathrm{S}} \times \mathrm{V}_{\mathrm{S}(\mathrm{MIN})}}}
$$

where $\mathrm{V}_{\mathrm{S}(\mathrm{MIN})}$ is the minimum voltage of the power source, $N_{P} / N_{S}$ is the primary to secondary turns ratio, and $\mathrm{V}_{\mathrm{O}}$ is the output voltage. The clamp capacitor, n-channel, and p-channel FETs must have breakdown voltages exceeding this level.
If feed-forward maximum duty-cycle clamp is used then:

$$
\begin{aligned}
& D_{\text {MAX-FF }}=\frac{V_{\mathrm{MIN}}}{2.43}=\left(1-\frac{\mathrm{V}_{\mathrm{DCLMP}}}{2.43}\right) \\
& =\left(1-\frac{\mathrm{V}_{S}}{2.43} \times \frac{R_{\mathrm{DCLMP}}}{\mathrm{R}_{\mathrm{DCLMP} 1}+\mathrm{R}_{\mathrm{DCLMP} 2}}\right)
\end{aligned}
$$

Therefore, $\mathrm{V}_{\text {CLAMP(MAX-FF) }}$ during feed-forward maximum duty clamp is:

$$
\begin{aligned}
& V_{\text {CLAMP }(M A X-F F)}=\frac{V_{S}}{1-D_{M A X-F F}} \\
& =\frac{2.43 \times\left(R_{\text {DCLMP1 }}+R_{\text {DCLMP2 }}\right)}{R_{\text {DCLMP2 }}}
\end{aligned}
$$

The AUX driver controls the p-channel FET through a level shifter. The level shifter consists of an RC network (formed by $\mathrm{C}_{\mathrm{A} U X}$ and $\mathrm{R}_{A U X}$ ) and diode D5, as shown in the Typical Application Circuits. Choose RAUX and $\mathrm{C}_{\mathrm{AUX}}$ so that the time constant exceeds 100/fsw. Diode D5 is a small-signal diode with a voltage rating exceeding 25 V .
Additionally, $\mathrm{C}_{\text {CLAMP }}$ should be chosen such that the complex poles formed with magnetizing inductance ( $L_{\text {MAG }}$ ) and $C_{\text {CLAMP }}$ are $2 x$ to $4 x$ away from the loop bandwidth:

$$
\frac{1-D}{2 \pi \sqrt{L_{M A G} \times C_{C L A M P}}}>3 \times f_{B W}
$$

## Bias Circuit

## Optocoupler Feedback (MAX5974C/MAX5974D)

An in-phase tertiary winding is needed to power the bias circuit when using optocoupler feedback. The voltage across the tertiary $\mathrm{V}_{\mathrm{T}}$ during the on-time is:

$$
\mathrm{V}_{\mathrm{T}}=\mathrm{V}_{\mathrm{OUT}} \times \frac{\mathrm{N}_{\mathrm{T}}}{\mathrm{~N}_{\mathrm{S}}}
$$

where $\mathrm{V}_{\text {OUT }}$ is the output voltage and $\mathrm{N}_{\mathrm{T}} / \mathrm{N}_{\mathrm{S}}$ is the turns ratio from the tertiary to the secondary winding. Select the turns ratio so that $\mathrm{V}_{\mathrm{T}}$ is above the UVLO shutdown level ( 7.35 V max) by a margin determined by the holdup time needed to "ride through" a brownout.

## Coupled-Inductor Feedback (MAX5974A/MAX5974B)

When using coupled-inductor feedback, the power for the devices can be taken from the coupled inductor during the off-time. The voltage across the coupled inductor, $V_{\text {COUPLED }}$, during the off-time is:

$$
\mathrm{V}_{\mathrm{COUPLED}}=\mathrm{V}_{\mathrm{OUT}} \times \frac{\mathrm{N}_{\mathrm{C}}}{\mathrm{~N}_{\mathrm{O}}}
$$

where $\mathrm{V}_{\text {OUT }}$ is the output voltage and $\mathrm{N}_{\mathrm{C}} / \mathrm{N}_{\mathrm{O}}$ is the turns ratio from the coupled output to the main output winding. Select the turns ratio so that VCOUPLED is above the UVLO shutdown level ( 7.5 V max) by a margin determined by the holdup time needed to "ride through" a brownout.
This voltage appears at the input of the devices, less a diode drop. An RC network consisting of RSNUB and $\mathrm{C}_{\text {SNUB }}$ is for damping the reverse recovery transients of diode D6.

## MAX5974A/MAX5974B/

MAX5974C/MAX5974D

During on-time, the coupled output is:

$$
\mathrm{V}_{\text {COUPLED-ON }}=-\left(\mathrm{V}_{\mathrm{S}} \times \frac{\mathrm{N}_{\mathrm{S}}}{\mathrm{~N}_{\mathrm{P}}}-\mathrm{V}_{\mathrm{OUT}}\right) \frac{\mathrm{N}_{\mathrm{C}}}{\mathrm{~N}_{\mathrm{O}}}
$$

where $V_{S}$ is the input supply voltage.
Care must be taken to ensure that the voltage at FB (equal to $\mathrm{V}_{\text {COUPLED-ON }}$ attenuated by the feedback resistive divider) is not more than 5 V :

$$
\mathrm{V}_{\mathrm{FB}-\mathrm{ON}}=\mathrm{V}_{\text {COUPLED-ON }} \times \frac{\mathrm{R}_{\mathrm{FB} 2}}{\left(\mathrm{R}_{\mathrm{FB} 1}+\mathrm{R}_{\mathrm{FB} 2}\right)}<5 \mathrm{~V}
$$

If this condition is not met, a signal diode should be placed from GND (anode) to FB (cathode).

## Active-Clamped, Spread-Spectrum, Current-Mode PWM Controllers

## Layout Recommendations

Typically, there are two sources of noise emission in a switching power supply: high di/dt loops and high dV/dt surfaces. For example, traces that carry the drain current often form high di/dt loops. Similarly, the heatsink of the main MOSFET presents a dV/dt source; therefore, minimize the surface area of the MOSFET heatsink as much as possible. Keep all PCB traces carrying switching currents as short as possible to minimize current loops. Use a ground plane for best results.
For universal AC input design, follow all applicable safety regulations. Offline power supplies can require UL, VDE, and other similar agency approvals.
Refer to the MAX5974A and MAX5974C Evaluation Kit data sheets for recommended layout and component values.

## Typical Application Circuits



## Typical Application Circuits (continued)



## Typical Application Circuits (continued)



## Ordering Information/Selector Guide

| PART | TOP MARK | PIN-PACKAGE | TEMP RANGE | UVLO <br> THRESHOLD (V) | FEEDBACK MODE |
| :--- | :---: | :---: | :---: | :---: | :---: |
| MAX5974AETE + | +AHY | 16 TQFN-EP* | $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ | 16 | Sample/Hold |
| MAX5974AATE+** | +AHY | 16 TQFN-EP* | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16 | Sample/Hold |
| MAX5974BETE + | +AHZ | 16 TQFN-EP* | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8.4 | Sample/Hold |
| MAX5974BATE+ | +AHZ | 16 TQFN-EP* | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8.4 | Sample/Hold |
| MAX5974CETE + | +AIA | 16 TQFN-EP* | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 16 | Continuously Connected |
| MAX5974CATE + | +AIA | 16 TQFN-EP* | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 16 | Continuously Connected |
| MAX5974DETE+ | +AIB | 16 TQFN-EP* | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8.4 | Continuously Connected |
| MAX5974DATE + | +AIB | 16 TQFN-EP* | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8.4 | Continuously Connected |

+Denotes a lead(Pb)-free/RoHS-compliant package.
*EP = Exposed pad.
**Future product-contact factory for availability.

## Chip Information

PROCESS: BiCMOS

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
| :---: | :---: | :---: | :---: |
| 0 | 6/10 | Initial release | - |
| 1 | 9/10 | Introduced the MAX5974B/MAX5974D. Updated the Absolute Maximum Ratings, Electrical Characteristics, Pin Description, the p-Channel MOSFET Gate Driver, Frequency Foldback for High-Efficiency Light-Load Operation sections, and Typical Application Circuits. | $\begin{aligned} & 1,2,3,12,15,17 \\ & 19,21,23,24,25 \end{aligned}$ |
| 2 | 6/11 | Added internal zener diode information | 1-10, 12-17, 19-25 |
| 3 | 10/13 | Updated COMP function in Pin Description, corrected pin name in UVLO on Power Source section, corrected Figures 1 and 2, corrected Typical Application Circuits | 11, 16, 24-26 |
| 4 | 10/14 | Added MAX5974DATE+ option to Ordering Information, Electrical Characteristics, and updated Typical Application Circuits | 1, 2-5, 25-27 |
| 5 | 7/15 | Removed EN from 2nd line in Absolute Maximum Ratings and changed the 1st line under Maximum Input/Output Current (continuous) from IN, NDRV, AUXDRV to EN | 2 |
| 6 | 7/17 | Updated Absolute Maximum Ratings section, Electrical Characteristics table, and Ordering Information table. | 2-6, 27 |
| 7 | 12/17 | Updated Absolute Maximum Ratings section, Electrical Characteristics table global characteristics, Startup Time Considerations section, and Ordering Information table. | 2-6, 22, 27 |
| 7.1 |  | Added future product designation to MAX5974AATE+in the Ordering Information table. | 27 |
| 8 | 11/20 | Updated General Description, Electrical Characteristics table, and Ordering Information/Selector Guide table. | 1, 3-6, 27 |

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[^0]:    Ordering Information/Selector Guide appears at end of data sheet.

[^1]:    For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

